WHAT IS CLAIMED IS:

1. An embedding resin for embedding an electronic part in an insulating substrate, assumes a color having a base color tone selected from among black, blue, green, red, orange, yellow, and violet.

2. The embedding resin according to claim 1, furthering comprising a thermosetting resin and at least one inorganic filler.

3. The embedding resin according to claim 2, wherein the thermosetting resin is at least one species selected from among a bisphenol-type epoxy resin, a naphthalene-type epoxy resin, a phenol-novolak-type epoxy resin, and a cresol-novolak-type epoxy resin.

4. The embedding resin according to claim 3, further comprising at least one coloring agent selected from among carbon black, a phthalocyanine-based pigment, an azo pigment, a quinoline-based pigment, an anthraquinone-based pigment, a triphenylmethane-based pigment, and an inorganic oxide.

5. The embedding resin according to claim 2, further comprising at least one coloring agent selected from among carbon black, a phthalocyanine-based pigment, an azo pigment, a quinoline-based pigment, an anthraquinone-based pigment, a triphenylmethane-based pigment, and an inorganic oxide.

6. The embedding resin according to claim 1, further comprising at least one coloring agent selected from among carbon black, a phthalocyanine-based pigment, an azo pigment, a quinoline-based pigment, an anthraquinone-based pigment, a triphenylmethane-based pigment, and an inorganic oxide.